

The KISS-101IL is a "Low Cost" *In-Line* Selective Soldering Machine ready to produce your product.

The KISS-101IL includes the following:

Standard Features:

- In line edge conveyor capable of integrating with up and down stream functions
- "Super Quick" motion for fastest processing times
- Windows 7 O/S with the interactive SWAK on machine programming interface (see the SWAK data sheet and video)
- Rapid setup and time to "first production", usually within 10 minutes

Automated Fiducial Correction

- Step and repeat capability in both X and Y axis for multiple boards in a panel
- Lead alloy solder pot and pump assembly included—lead free alloy (all titanium) and HMP alloy pot and pump available
- Precision KFS-SP atomizing flux applicator
- Process witness camera
- 6mm and 12mm "Bullet" nozzles
- Heated Nitrogen to the solder nozzle
- Programmable flux deposition
- Programmable solder wave flow rate
- Programmable Solder Pot Timer
- Automated in process solder wave height check / adjust
- Automated solder pot level check and fill
- Set the time/temp profile for each individual component type for maximized process control and TAKT time
- Absolute control over all critical process parameters:
 - Solder temperature interlocked to within 10°C
 - Height and travel speed of the solder wave
 - Programmable initial pre-heat soak time
- Set-up kit, on site installation and training included
- One year warranty covering the entire machine and two

Model KISS-101IL

"Keep It Simple Soldering

In-Line Selective Soldering 12" x 12" Platform

(300mm x 300mm)

Overview:

The KISS-101IL is the automated in-line version of the manual loaded KISS-101 machine. The KISS-101IL performs the soldering of 'through hole" components to PCBs in a "lights out" in-line process while maintaining the PCB stationary which prevents components from toppling over causing "unset" inter-metallic fillets. The KISS-101IL is an automated selective soldering machine using the proven 'traveling mini-solder wave".

The KISS-101IL is used to flux and solder through hole components on SMT boards within close proximity of adjacent components. The KISS-101IL overcomes the limitations and high costs of operator dependent soldering with a truly flexible automated flux application and molten solder delivery system.

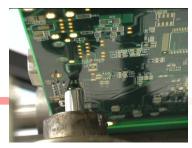
The KISS-101IL couples high throughput with precise process controls. The programmable features provide the tools to set all process parameters, including immersion depths, pre-heat dwells, travel distances and speeds, solder temperature and wave height.

The KISS-101IL will out produce 4 or more operators soldering with an iron while significantly increasing the solder joint quality and to a predictable schedule.

"You can expect a ROI of 4 months or less"

Process overview:

The automated process begins with the PCB/panel entering the KISS-101IL on the edge rail conveyors built into the system. The Automated Fiducial Correction identifies the location of 2 points on the board and resets the zero start position. The cycle begins by applying flux precisely to all the sites to be soldered. Next the mini solder wave is automatically moved under the components to be soldered. The solder nozzle raises to just below the site allowing the heated nitrogen to pre-heat the site and activate the flux. The nozzle raises up further immersing the first of the leads, dwelling for initial "soak". The nozzle travels over the entire site leaving perfect top and bottom side fillets at each pin. At the completion of the travel the solder pot lowers and moves to the next site. After completing all sites the pot returns to the start position ready for the next cycle while the completed PCB/panel conveys out, downstream.



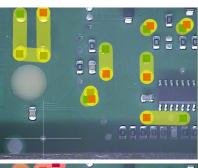


Programming:

The programming is accomplished by one of two methods on the machine or with the optional Offline Teach programming interface software. On the machine use the set up camera viewed on the monitor and point-and-click method to set the flux and solder pattern in real time. Usually an average board can be programmed within 10 minutes. You can fine tune the X,Y and Z positions, speeds, solder wave height and other parameters to perfect the process.

Optionally, at your desktop import a JPEG (photo) or the Gerber file into the Offline Teach program. Pick the solder nozzle size (this becomes your curser). Choose the start/ stop positions for all devices to be soldered. The process path becomes highlighted and script is automatically created for you. Circular or angular interpolation allows the soldering of large round arrays in a spiral pattern and connectors not perpendicular to the X-Y plane (see the SWAK data sheet and video).

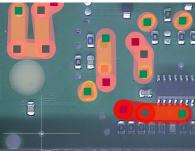
Set the zero point, then choose the flux width and solder nozzle and "paint" the process paths. It is that easy.



Programming the flux paths



Applying the flux



Programming the solder paths



Soldering the components

Options: (see individual data sheets)

- Additional solder pot/pump assemblies for Pb, Sn or HMP alloys
- Additional "Bullet" or "Wave" solder nozzles and W-75 wide wave nozzle for mass wave soldering
- Drop jet precision flux applicator (for no-clean processing)
- Additional witness camera
- Dual monitors (great for simultaneous video feed from cameras)
- Offline programming software

The KISS solder pots (See the KISS-SPA data sheet)





"Wave" nozzles







"Bullet" nozzles

KISS-101IL Specifications:

PCB Panel Size

Minimum Maximum 2" x 2" 12" x 12" (50mm x 50mm) (300mm x 300mm)

Speed 0-3 inches/sec

Safe "Keep Away" (distance to adjacent pads) 1mm

<u>Motion</u>

Z-Axis

X and Y Axis

Solder Pot

TemperatureSolder Capacity

• Pump

Software

PhysicalDimensions

• Weight (dry)

• Weight (u)

Facilities

• Power Domestic International

AirNitrogen

Exhaust

Accuracy/Repeatability +/-.002" Speed 0-4 inches/sec

Accuracy/Repeatability +/-.002"

PID proportioning $(0-400^{\circ}\text{C}) \pm 2^{\circ}\text{C}$ 30 lbs. (14 kilos) PC controlled

Windows 7 O/S and SWAK programming interface

54" wide x 40" deep x 45" high (1371mm wide x 1016mm deep x 1143mm high)

650 lbs. (295 kilos)

120VAC/1 Ph/60 Hz 15 amps 208-230VAC/1 Ph/60 Hz 8 amps 90 (minimum) to 100 (maximum) PSI 99 999% pure 30-50 CEH @ 60

99.999% pure, 30-50 CFH @ 60 (minimum) to 100 (maximum) PSI

250 CFM recommended

(2) 4" dia. Take-offs at rear panel

Certification of compliance:

OSHA, NEC, CE, UL, ULC

Call for a free video of the KISS machines and the selective soldering process